

Form Type	Distribute	Version	n 2.0		Ref		IPC 1752A		Sectionals		Manufacturing Info/ Material Info		Subsectionals	D, A
'		1			s	upplier I	nformatio	n			•		•	
Company Name	TE Connectiv		Request Document ID				Name	Walther, Dirk		Contact Title		Mgr Project Management Engineering		
Company Unique ID	TE Connectiv	ity Response Date		2017-01-11		Contact Email		dwalther@te.com						
Contact Phone	Number	+49-6251-13	33338	2		•								
						Legal S	tatement							
Supplier Acceptance	true													
_egal Statemen	t													
The information provided in the control of the cont	provided in this	document is base ecifications or ex	d upo	n reasonat	le inqui	ry of our	suppliers.	This inf	ormation is	subje	ct to change.	Thi	is information doe	es not in any
,	9 р за селото с с		<u>9</u>				duct				., (
Manufacturer tem number	1376352-1	Amount	Amount		1.58		Version -		Iden		tity			
Manufacturer tem Name	025 I/O PLUG HSG ASSY 8		Weight Uom		g		е			Authority				
Date		UOM		Each										
EURoHS-0508	Product(s) me	duct(s) meets EU RoHS requirement without any exemptions												
ChinaRoHS-	` ' '	eligible for markin						or Adm	inistration o	f the	control of poll	utio	n by Electronic Ir	nformation
EUREACH-1215	1	lidate Substances	of Ve	ery Hiah Ca	ncern A	RE NOT	Containe	d in the	Product Ah	ove th	ne Limits per	the	Definition within	REACH
2				, 550			g Inform							
J-STD-020 MSL Rating		Max Total a Wave Time				Ramp Rate			Wav Addi		e itional Info			
Classification Temp		Max Wave Solder Tir		0.0		Ramp Down Rate					Rating			
Max Time Within 5		Psl Rating Wave			Package Designa					Size		0.0		
Time Above 217	,	Reflow Additional					Preheat Max Temp		Tern				ot Applicable	
Preheat Duration			bulk Solder Termination		Not Applicable		Nbr or Reflow Cycles		Tern Plati			Not Applicable		
Preheat Min Temp		Nbr of Instances			0		Component Temp Spike		Shap		ре	Not Applicable		
•	•	•		•	F	Product I	Disclosur	e		•				
Sub- Item/Material/	Level	Name	Substance Category		Substa CAS	Substar Concer					Mass per U	nit	UOM	Exemption
Substance Sub-Item	1	025 I/O RETAINER 8P								1.0			g	
Material	2	PBT								1.0			g	
Substance	3	1,4- Benzenedicarb oxylic acid, polymer with 1,4-butanediol	Supplier		26062-94-2		99.0		1.0		0.1782		g	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier		TE5081-2- 1212		1.0		1.0		0.0018		g	
Sub-Item	1	025 I/O PLUG HSG 8P							1.0		1.4		g	
Material	2	PBT							1.0		1.4		g	
Substance	3	1,4- Benzenedicarb oxylic acid, polymer with 1,4-butanediol	Supplier		26062-94-2		99.0		1.0		1.386		g	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier		TE5081-2- 1212		1.0		1.0		0.014		g	